D1 FC:8021



Docket No. JCLA11536

102881255 RECORDATION FORM COVER SHEET Form 1595 U.S. Department of Commerce 1-31-92 Patent and Trademark Office PATENTS ONLY To the Honorable Assistant Commissioner for Patents: Please record the attached original documents or copy thereof. 1. Name of conveying party(ies): 2. Name/address of receiving Party(ies): Tzung-Han Lee United Microelectronics Corp. Kuang-Pi Lee Wen-Jeng Lin No. 3, Li-Hsin Rd. II, Science-Based Rern-Hurng Larn Nature of conveyance: Industrial Park, Hsinchu, Taiwan, **☒** Assignment ☐ Merger ☐ Security Agreement ☐ Other R.O.C. ☐ Change of Name ☐ Reassignment Add'1 names of receiving parties Attached? 🔲 Yes 🗵 No 4. Date(s) of execution: October 1, 2004 5. Application number(s) or patent number(s): If this documents is being filed together with a new application, the execution date of the application is October 1, 2004. Patent Application No. (s) B. Patent No. (s) Additional numbers attached ? ☐ Yes ⊠ No Total No. of applications and patents Name and address of party to whom involved: Correspondence concerning document should be mailed: ONE(1) Total fee (37 CFR §3.41): \$40.00 J.C. Patents, Inc. Enclosed 4 Venture, Suite 250 Irvine, CA 92618 Charge to Acct. No. (949) 660-0761 Total number of pages, including Cover sheet, attachments and document 3. DO NOT USE THIS SPACE 10. Statement and Signature: To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document. Jiawei Huang Name of Person Signing Signature 1/12/2004 NGETHERE SECRETORS 10983420330 40.00 OP

> PATENT REEL: 015971 FRAME: 0043

## **ASSIGNMENT**

WHEREAS.

1. Tzung-Han Lee

2. Kuang-Pi Lee

3. Wen-Jeng Lin

4. Rern-Hurng Larn

hereinafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as described and set forth in the below identified application for United States Letters Patent:

Title: SRAM CELL STRUCTURE AND MANUFACTURING METHOD
THEREOF

[ ] Filed:

Serial No.

[x] Executed concurrently with the execution of this instrument

WHEREAS, United Microelectronics Corp.

of No. 3, Li-Hsin Rd. II, Science-Based Industrial Park, Hsinchu, Taiwan, R.O.C.

hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same:

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assigner further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee Lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

## ASSIGNMENT CONTINUED

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s) indicated. Sole or First Joint Inventor: Tzung-Han Lee October 1, 2004 Date: Second Joint Inventor(if any): Kuang-Pi Lee Third Joint Inventor(if any): Wen-Jeng Lin October 1, 2004

Fourth Joint Inventor(if any): Rern-Hurng Larn

**RECORDED: 11/04/2004**